MM54C74,MM74C74

MM54C74 MM74C74 Dual D Flip-Flop

Literature Number: SNOS336A

National Semiconductor

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MM54C74/MM74C74 Dual D Flip-Flop

General Description

The MM54C74/MM74C74 dual D flip-flop is a monolithic complementary MOS (CMOS) integrated circuit constructed with N- and P-channel enhancement transistors. Each flip-flop has independent data, preset, clear and clock inputs and Q and $\overline{Q}$ outputs. The logic level present at the data input is transferred to the output during the positive going transition of the clock pulse. Preset or clear is independent of the clock and accomplished by a low level at the preset or clear input.

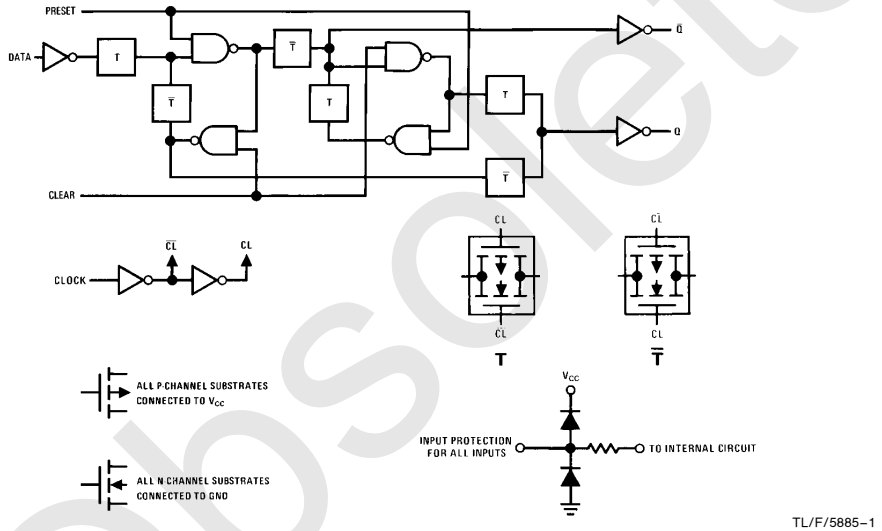
Features

■ Supply voltage range	3V to 15V
■ Tenth power TTL compatible	Drive 2 LPT^{2}L loads
■ High noise immunity	0.45 V_{CC} (typ.)
■ Low power	50 nW (typ.)
■ Medium speed operation	10 MHz (typ.) with 10V supply

Applications

- Automotive
- Data terminals
- Instrumentation
- Medical electronics
- Alarm system
- Industrial electronics
- Remote metering
- Computers

Logic Diagram



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Truth Table

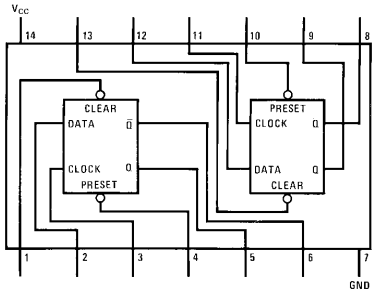
Preset	Clear	Q_n	$\overline{Q}_n$
0	0	0	0
0	1	1	0
1	0	0	1
1	1	*Q_n	*$\overline{Q}_n$

*No change in output from previous state.

Order Number MM54C74 or MM74C74

Connection Diagram

Dual-In-Line Package



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Top View

Note: A logic "0" on clear sets Q to logic "0".
A logic "0" on preset sets Q to logic "1".

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Voltage at Any Pin (Note 1)	−0.3V to V_{CC} +0.3V
Operating Temperature Range	
MM54C74	−55°C to +125°C
MM74C74	−40°C to +85°C
Storage Temperature Range	−65°C to +150°C
Power Dissipation	
Dual-In-Line	700 mW
Small Outline	500 mW
Lead Temperature (Soldering, 10 seconds)	260°C
Operating V_{CC} Range	3V to 15V
V_{CC}(Max)	18V

DC Electrical Characteristics Min/Max limits apply across temperature range unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
CMOS TO CMOS						
$V_{IN(1)}$	Logical "1" Input Voltage	V_{CC} = 5V	3.5			V
		V_{CC} = 10V	80			V
$V_{IN(0)}$	Logical "0" Input Voltage	V_{CC} = 5V			1.5	V
		V_{CC} = 10V			2.0	V
$V_{OUT(1)}$	Logical "1" Output Voltage	V_{CC} = 5V	4.5			V
		V_{CC} = 10V	9.0			V
$V_{OUT(0)}$	Logical "0" Output Voltage	V_{CC} = 5V			0.5	V
		V_{CC} = 10V			1.0	V
$I_{IN(1)}$	Logical "1" Input Current	V_{CC} = 15V			1.0	μA
$I_{IN(0)}$	Logical "0" Input Current	V_{CC} = 15V	−1.0			μA
I_{CC}	Supply Current	V_{CC} = 15V		0.05	60	μA
CMOS/LPTTL INTERFACE						
$V_{IN(1)}$	Logical "1" Input Voltage	54C, V_{CC} = 4.5V 74C, V_{CC} = 4.75V	V_{CC}−1.5			
$V_{IN(0)}$	Logical "0" Input Voltage	54C, V_{CC} = 4.75V 74C, V_{CC} = 4.75V			0.8	V
$V_{OUT(1)}$	Logical "1" Output Voltage	54C, V_{CC} = 4.5V, I_D = −360 μA 74C, V_{CC} = 4.75V, I_D = −360 μA	2.4			V
$V_{OUT(0)}$	Logical "0" Output Voltage	54C, V_{CC} = 4.5V, I_D = 360 μA 74C, V_{CC} = 4.75V, I_D = 360 μA			0.4	V
OUTPUT DRIVE (See 54C/74C Family Characteristics Data Sheet)						
I_{SOURCE}	Output Source Current	V_{CC} = 5V, $V_{IN(0)}$ = 0V T_A = 25°C, V_{OUT} = 0V	−1.75			mA
I_{SOURCE}	Output Source Current	V_{CC} = 10V, $V_{IN(0)}$ = 0V T_A = 25°C, V_{OUT} = 0V	−8.0			mA
I_{SINK}	Output Sink Current	V_{CC} = 5V, $V_{IN(1)}$ = 5V T_A = 25°C, V_{OUT} = V_{CC}	1.75			mA
I_{SINK}	Output Sink Current	V_{CC} = 10V, $V_{IN(1)}$ = 10V T_A = 25°C, V_{OUT} = V_{CC}	8.0			mA

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

AC Electrical Characteristics* $T_A = 25°C$, $C_L = 50$ pF, unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
C_{IN}	Input Capacitance	Any Input (Note 2)		5.0		pF
t_{pd}	Propagation Delay Time to a Logical "0" t_{pd0} or Logical "1" t_{pd1} from Clock to Q or $\overline{Q}$	$V_{CC} = 5V$ $V_{CC} = 10V$		180 70	300 110	ns ns
t_{pd}	Propagation Delay Time to a Logical "0" from Preset or Clear	$V_{CC} = 5V$ $V_{CC} = 10V$		180 70	300 110	ns ns
t_{pd}	Propagation Delay Time to a Logical "1" from Preset or Clear	$V_{CC} = 5V$ $V_{CC} = 10V$		250 100	400 150	ns ns
t_{S0}, t_{S1}	Time Prior to Clock Pulse that Data Must be Present t_{SETUP}	$V_{CC} = 5V$ $V_{CC} = 10V$	100 40	50 20		ns ns
t_{H0}, t_{H1}	Time after Clock Pulse that Data Must be Held	$V_{CC} = 5V$ $V_{CC} = 10V$		−20 −8.0	0 0	ns ns
t_{PW1}	Minimum Clock Pulse Width ($t_{WL} = t_{WH}$)	$V_{CC} = 5V$ $V_{CC} = 10V$		100 40	250 100	ns ns
t_{PW2}	Minimum Preset and Clear Pulse Width	$V_{CC} = 5V$ $V_{CC} = 10V$		100 40	160 70	ns ns
t_r, t_f	Maximum Clock Rise and Fall Time	$V_{CC} = 5V$ $V_{CC} = 10V$	15.0 5.0			μs μs
f_{MAX}	Maximum Clock Frequency	$V_{CC} = 5V$ $V_{CC} = 10V$	2.0 5.0	3.5 8.0		MHz MHz
C_{PD}	Power Dissipation Capacitance	(Note 3)		40		pF

*AC Parameters are guaranteed by DC correlated testing.

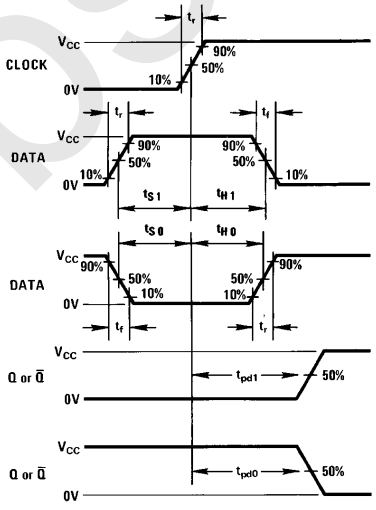
Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Capacitance is guaranteed by periodic testing.

Note 3: C_{PD} determines the no load AC power consumption of any CMOS device. For complete explanation see 54C/74C Family Characteristics Application Note—AN-90.

Switching Time Waveform

CMOS to CMOS



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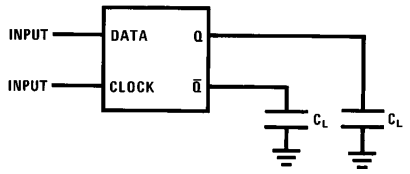
$t_r = t_f = 20$ ns

AC Test Circuit



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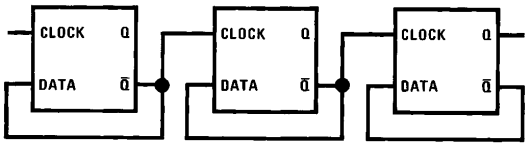
Typical Applications

Ripple Counter (Divide by 2^n)



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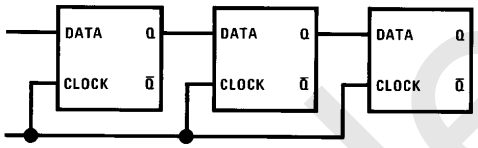
Shift Register



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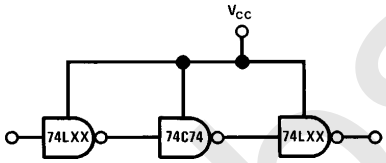
74C Compatibility



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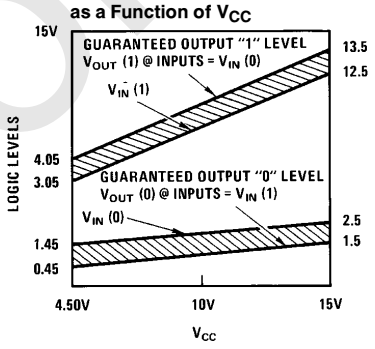
Guaranteed Noise Margin as a Function of V_{CC}



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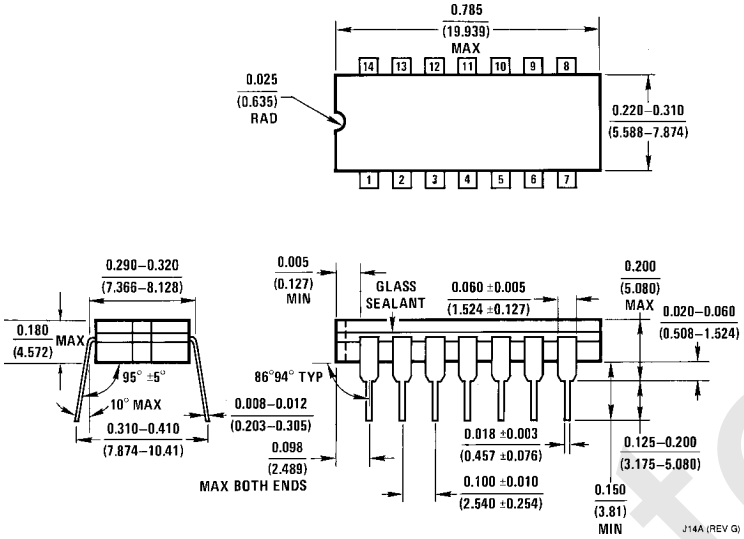
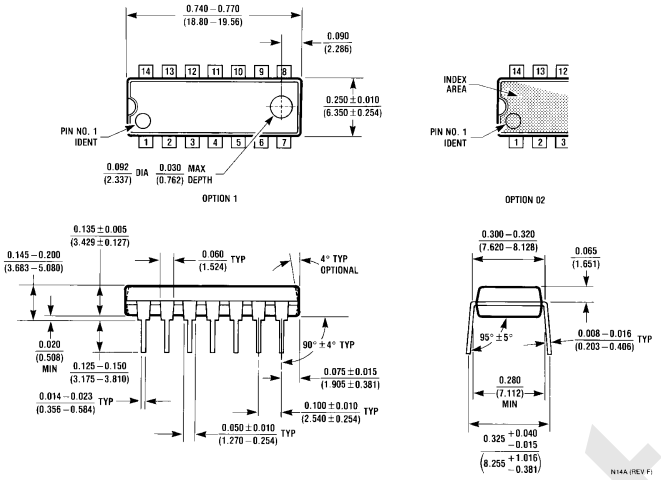
Physical Dimensions inches (millimeters)



Ceramic Dual-In-Line Package (J)
Order Number MM54C74J or MM74C74J
NS Package Number J14A

Physical Dimensions inches (millimeters) (Continued)



Ceramic Dual-In-Line Package (J)
Order Number MM54C74N or MM74C74N
NS Package Number N14A

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